

VDS	RDS(on)	ID@25℃
650V	20mΩ	92A

Applications:

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- EV Charging
- Motor Drives

Features:

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness

Benefits:

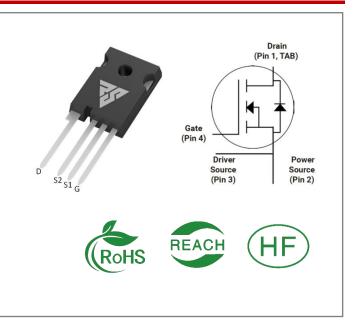
- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Ordering Information

Part Number	Package	Marking	Packing	Qty.
RSM065020Z	TO-247-4	RSM065020Z	Tube	30 PCS

Maximum Ratings (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VDSmax	Drain - Source Voltage	650	V	VGS=0V,ID =100µA	
VGSmax	Gate - Source Voltage	-8/+22	V Absolute maximum values		
VGSop	Gate - Source Voltage	-5/+18	V	Recommended operational values	
ID	Continuous Drain Current	92 64	А	VGS=18V, TC =25℃ VGS=18V, TC =100℃	
ID(pulse)	Pulsed Drain Current	257	А	Pulse width tp limited by TJmax	
PD	Power Dissipation	312	W	TC =25℃, TJ =175℃	
TL	Solder Temperature	260	°C		
TJ, Tstg	Operating Junction and StorageTemperature	-55 to + 175	°C		





Electrical Characteristics (TJ= 25°C unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
V(BR)D SS	Drain-Source Breakdown Voltage	650			V	VGS=0V,ID =100µA	
VGS(th)	Gate Threshold	1.9	2.6	4.0	V	VGS= VDS, IDS=15mA, TC =25℃	
vG3(th)	Voltage		1.8		V	VGS= VDS, IDS=15mA, TC =175℃	
IDSS	Zero Gate Voltage Drain Current		1	100	μΑ	VDS= 650V, VGS=0V	
IGSS+	Gate-Source Leakage Current		10	250	nA	VGS=22V, VDS= 0V	
IGSS-	Gate-Source Leakage Current		10	250	nA	VGS=-8V, VDS= 0V	
RDS(on)	Drain-Source on-state		20	30	mΩ	VGS=18V, ID =50A, TC =25℃	
KD3(0H)	Resistance		28			VGS=18V, ID =50A, TC =175℃	
Ciss	Input Capacitance		318 0			VGS=0V, VDS=400 V,	
Coss	Output Capacitance		281		pF	f=1MHz, VAC=25 mV	
Crss	Reverse Transfer Capacitance		33				
EON	Turn-On Switching Energy		520		μJ	VDS =400V, VGS =-4/18V, ID = 30A,	
EOFF	Turn-Off Energy		700		μ	RG(ext) = 2.5Ω, L= 100μ H	
td(on)	Turn-On Delay Time		17				
tr	Rise Time		15		ns	VDS =400V, VGS =-4/18 V ID = 30A, RG(ext) =2. 5 Ω ,	
td(off)	Turn-Off Delay Time		65		115	$RL = 20\Omega$	
tf	Fall Time		14				
RG(int)	Internal Gate Resistance		3.2		Ω	f=1 MHz, VAC=25mV	
Qgs	Gate to Source Charge		49		nC	nC VDS=400V, nC VGS=-4/18V ID = 30A	
Qgd	Gate to Drain Charge		31		nC		
Qg	Total Gate Charge		187				



Reverse Diode Characteristics (TJ= 25° C unless otherwise specified)

Symbol	Parameter	Тур.	Ma x	Unit	Test Conditions	Note
VSD	Diada Famuard Valtaga	4.2		V	VGS=-4V, ISD = 25 A, TJ = 25℃	
V3D	Diode Forward Voltage	3.8		V	VGS=-4V, ISD=25 A, TJ= 175℃	
IS	Continuous Diode Forward Current		72	А	VGS=-4V,TC= 25 ℃	
trr	Reverse Recovery time	26		ns		
Qrr	Reverse Recovery Charge	58		nC	ISD= 30 A, VR = 400V	
Irrm	Peak Reverse Recovery Current	3.4		А		

Thermal Characteristics (TJ= 25° C unless otherwise specified)

Symbol	Parameter	Тур.	Unit	Test Conditions	Not e
RθJC	Thermal Resistance from Junction to Case	0.48	°C/W		
RθJA	Thermal Resistance From Junction to Ambient	40			



Typical Feature Curve

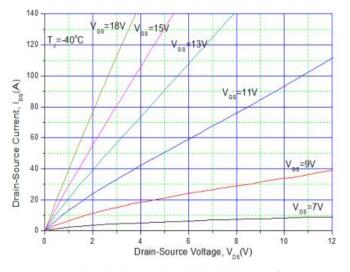


Figure 1. Output Characteristics T₁ = -40°C

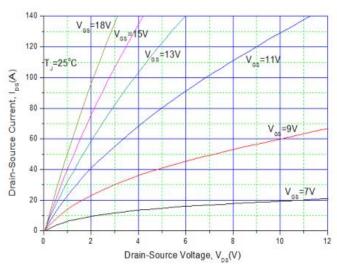


Figure 2. Output Characteristics T_J = 25°C

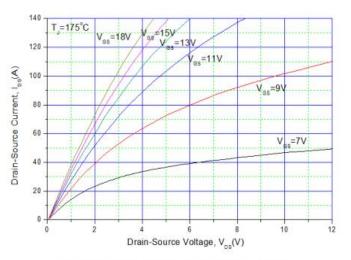
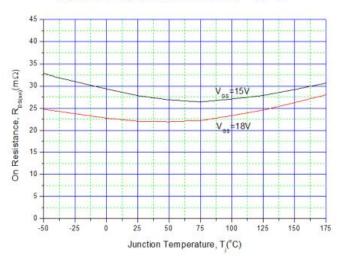
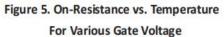


Figure 3. Output Characteristics T₁ = 175°C





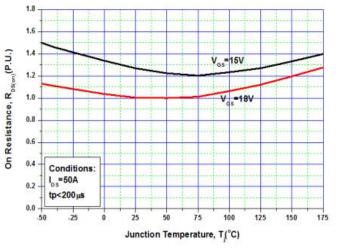


Figure 4. Normalized On-Resistance vs. Temperature

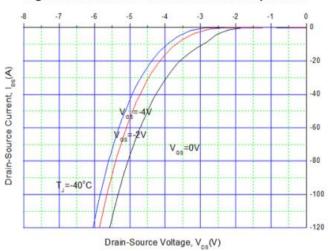


Figure 6. Body Diode Characteristic at -40°C

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-2

-0V

0

0

-20

-40

-60

-80

-100

-120

0

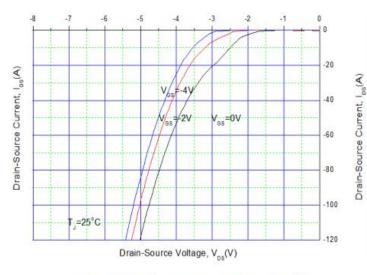


Figure 7. Body Diode Characteristic at 25°C



Drain-Source Voltage, Vps(V)

-6

T_=175°C

-5

-4

V ==

4

12V

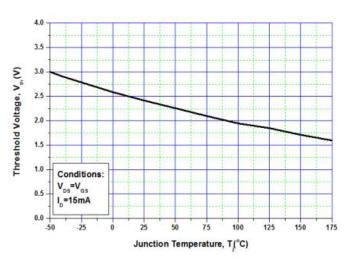
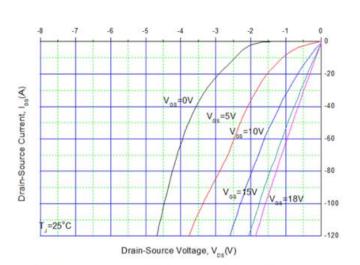


Figure 9. Threshold Voltage vs. Temperature





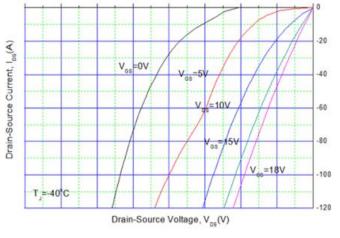


Figure 10. 3rd Quadrant Characteristic at -40℃

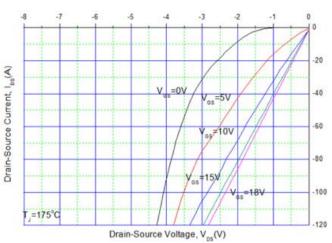
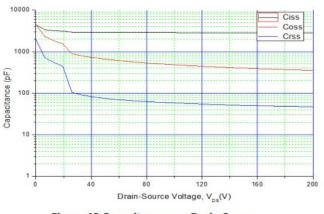
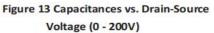


Figure 12 3rd Quadrant Characteristic at 175°C

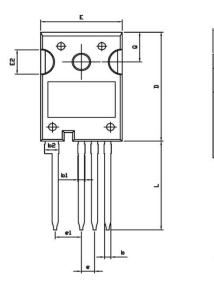
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Package outline drawing(TO-247-4 Unit: mm)



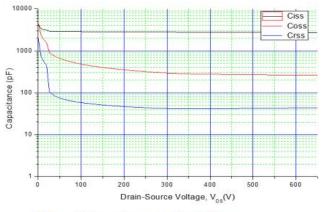
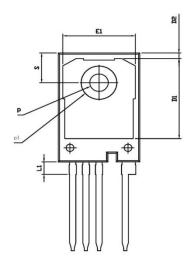


Figure 14 Capacitances vs. Drain-Source Voltage (0 - 650V)



RECOMMENDED LAND PATTERN



UNIT: mm

	MIN	NOM	MAX
Α	4.80	5.00	5.20
A1	2.25	2.40	2.45
A2	1.85	2.00	2.15
b	1.05	1.20	1.35
b1	1.00	1.30	1.60
b2	2.35	2.65	2.95
с	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.50	17.00
D2	0.97	1.17	1.37
е	2.34	2.54	2.74
e1	4.88	5.08	5.28
Е	15.60	15.80	16.00
E1	13.50	14.00	14.50
E2	4.80	5.00	5.20
L	18.08	18.38	18.68
L1	2.38	2.58	2.78
р	3.50	3.60	3.70
p1	6.60	6.80	7.00
Q	6.00	6.15	6.30
S	6.00	6.15	6.30

A1

c



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